



P-Channel 1.8-V (G-S) MOSFET

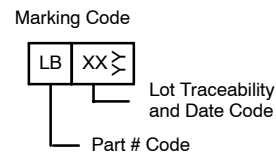
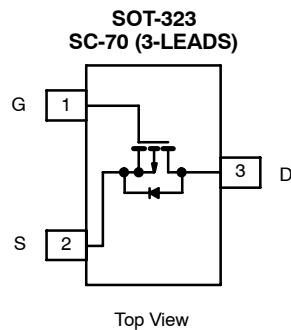
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
-8	0.280 @ $V_{GS} = -4.5$ V	-0.92
	0.380 @ $V_{GS} = -2.5$ V	-0.79
	0.530 @ $V_{GS} = -1.8$ V	-0.67

FEATURES

- TrenchFET® Power MOSFET: 1.8 V Rated



RoHS
COMPLIANT



Ordering Information: Si1305DL--T1
Si1305DL--T1--E3 (Lead (Pb)-Free)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)				
Parameter		Symbol	5 secs	Steady State
Drain-Source Voltage		V_{DS}	-8	
Gate-Source Voltage		V_{GS}	± 8	
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	$T_A = 25^\circ\text{C}$	I_D	-0.92	-0.86
	$T_A = 70^\circ\text{C}$		-0.74	-0.69
Pulsed Drain Current		I_{DM}	-3	
Continuous Diode Current (Diode Conduction) ^a		I_S	-0.28	-0.24
Maximum Power Dissipation ^a	$T_A = 25^\circ\text{C}$	P_D	0.34	0.29
	$T_A = 70^\circ\text{C}$		0.22	0.19
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 5$ sec	R_{thJA}	315	375	$^\circ\text{C/W}$
	Steady State		360	430	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	285	340	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

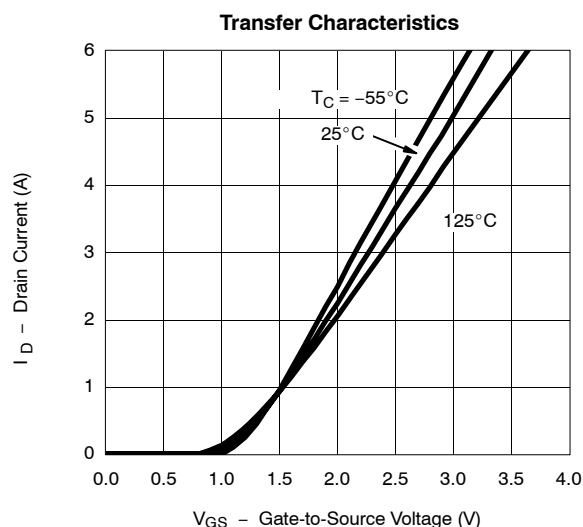
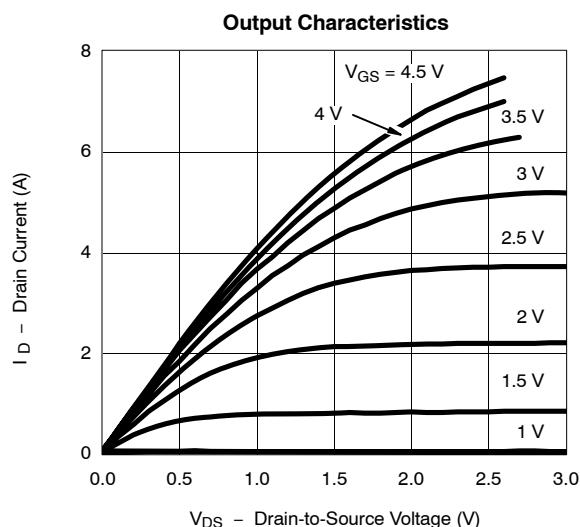
SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}, V_{GS} = \pm 8\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -8\ \text{V}, V_{GS} = 0\ \text{V}$			-1	μA
		$V_{DS} = -8\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 70^\circ\text{C}$			-5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -5\ \text{V}, V_{GS} = -4.5\ \text{V}$	-3			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = -4.5\ \text{V}, I_D = -1\ \text{A}$		0.230	0.280	Ω
		$V_{GS} = -2.5\ \text{V}, I_D = -0.5\ \text{A}$		0.315	0.380	
		$V_{GS} = -1.8\ \text{V}, I_D = -0.3\ \text{A}$		0.440	0.530	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -5\ \text{V}, I_D = -1\ \text{A}$		3.5		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -0.3\ \text{A}, V_{GS} = 0\ \text{V}$			-1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -4\ \text{V}, V_{GS} = -4.5\ \text{V}, I_D = -1\ \text{A}$		2.6	4	nC
Gate-Source Charge	Q_{gs}			0.6		
Gate-Drain Charge	Q_{gd}			0.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -4\ \text{V}, R_L = 4\ \Omega$ $I_D \cong -1\ \text{A}, V_{GEN} = -4.5\ \text{V}, R_g = 6\ \Omega$		8	15	ns
Rise Time	t_r			55	80	
Turn-Off Delay Time	$t_{d(off)}$			17	25	
Fall Time	t_f			12	20	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -1\ \text{A}, di/dt = 100\ \text{A}/\mu\text{s}$		27	45	

Notes

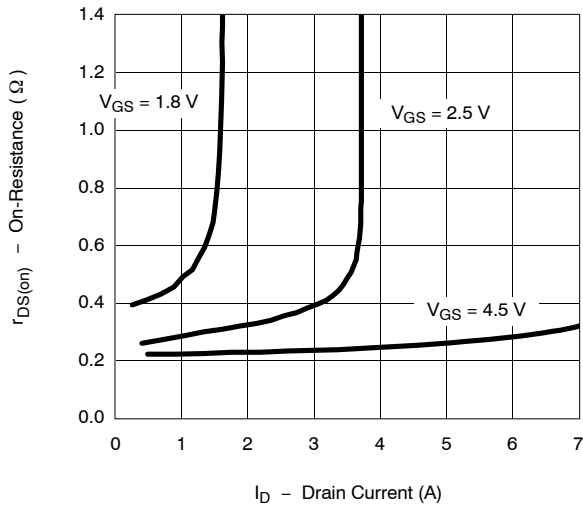
- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

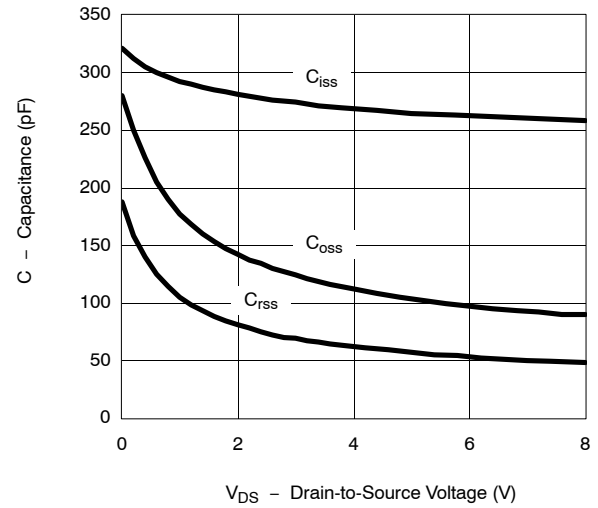
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

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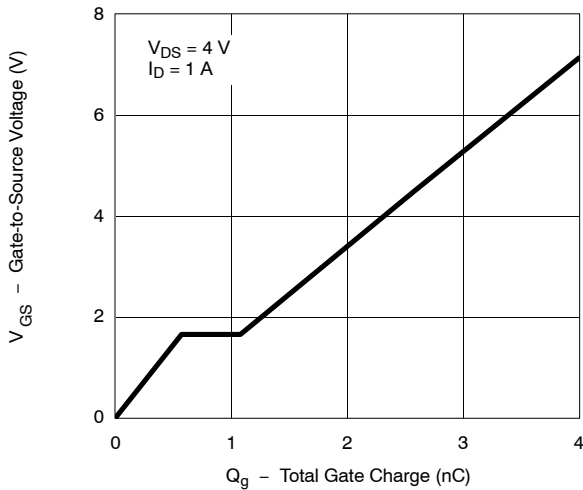
On-Resistance vs. Drain Current



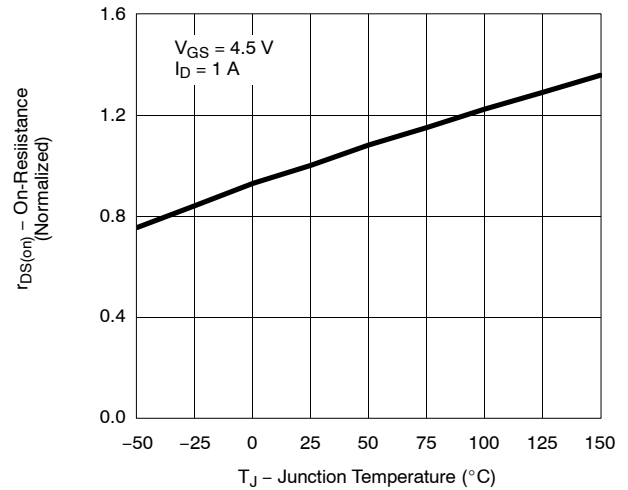
Capacitance



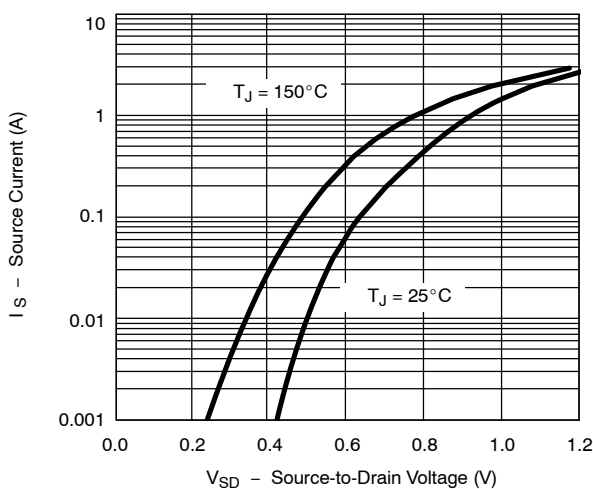
Gate Charge



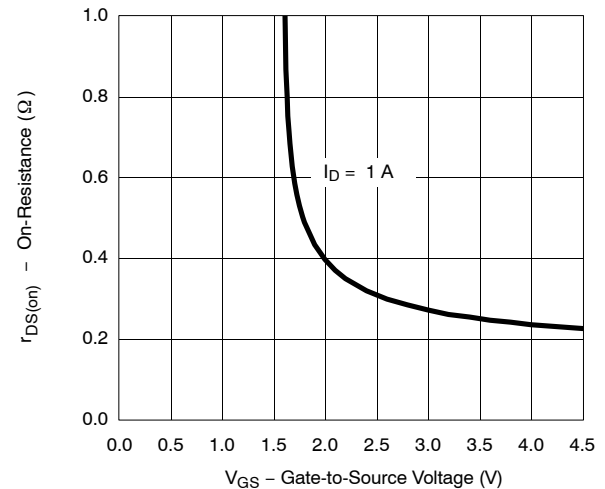
On-Resistance vs. Junction Temperature



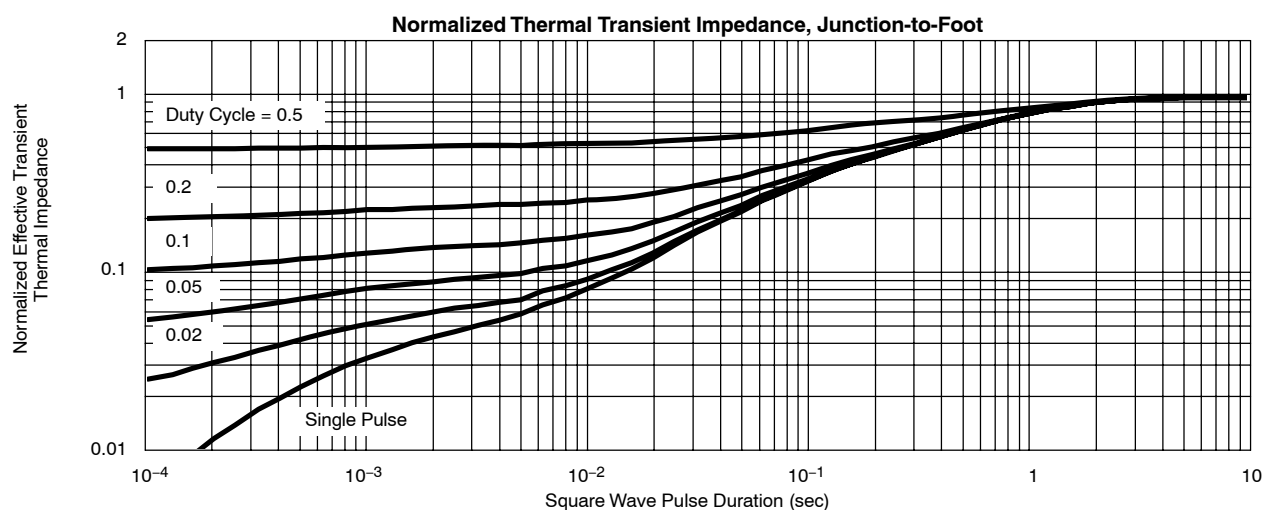
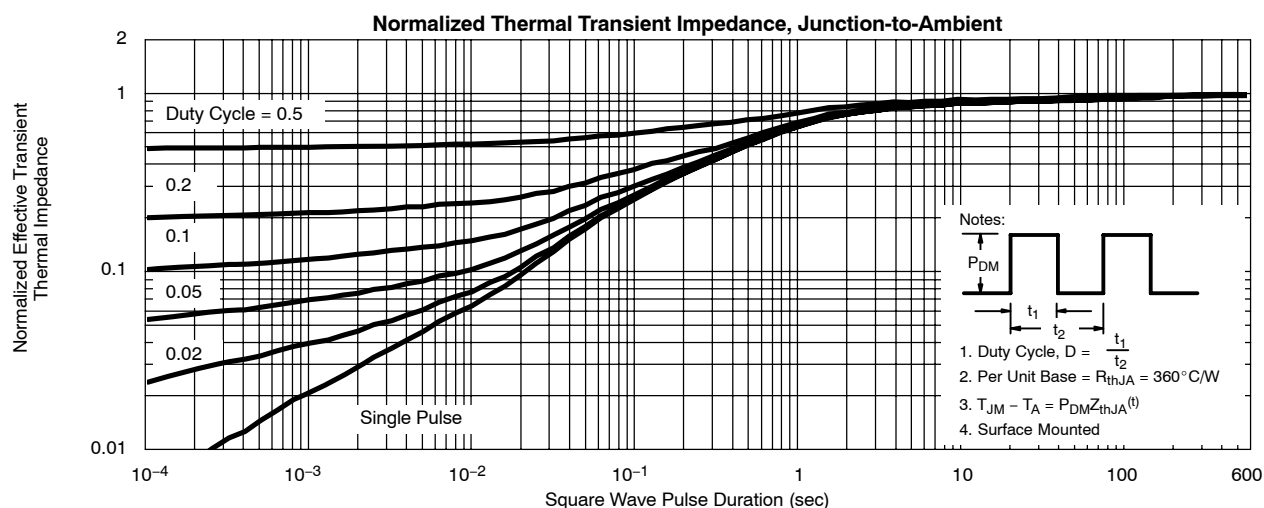
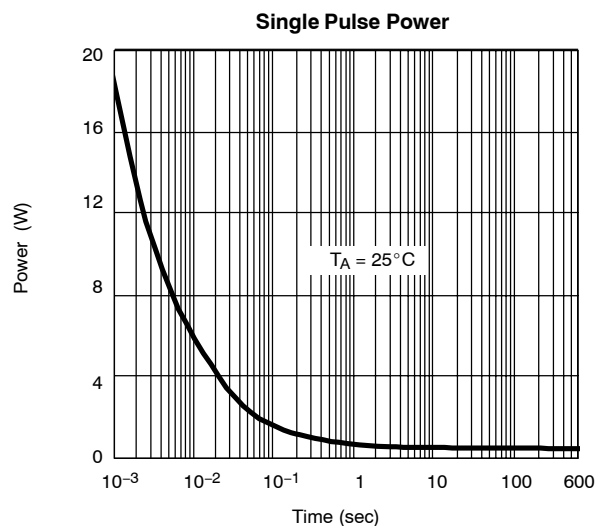
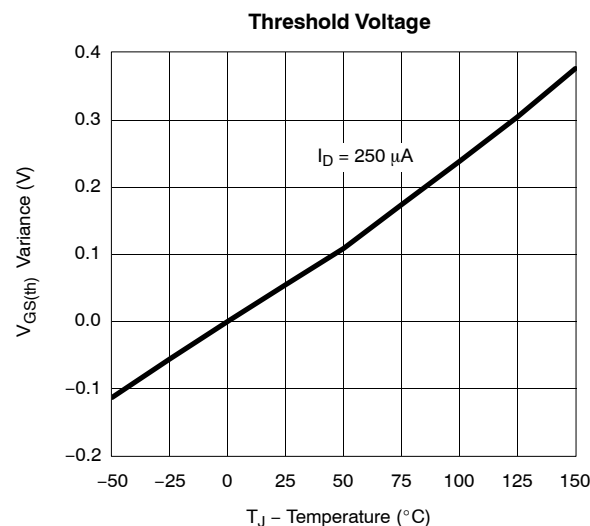
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)



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